

October 1987 Revised January 1999

## CD4094BC 8-Bit Shift Register/Latch with 3-STATE Outputs

#### **General Description**

The CD4094BC consists of an 8-bit shift register and a 3-STATE 8-bit latch. Data is shifted serially through the shift register on the positive transition of the clock. The output of the last stage  $(Q_S)$  can be used to cascade several devices. Data on the  $Q_S$  output is transferred to a second output,  $Q^\prime_S$ , on the following negative clock edge.

The output of each stage of the shift register feeds a latch, which latches data on the negative edge of the STROBE input. When STROBE is HIGH, data propagates through

the latch to 3-STATE output gates. These gates are enabled when OUTPUT ENABLE is taken HIGH.

#### **Features**

■ Wide supply voltage range: 3.0V to 18V■ High noise immunity: 0.45 V<sub>DD</sub> (typ.)

■ Low power TTL compatibility:

Fan out of 2 driving 74L or 1 driving 74LS

■ 3-STATE outputs

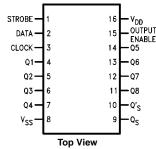
#### **Ordering Code:**

Order Number	Package Number	Package Description
CD4094BCWM	M16B	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
CD4094BCN	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

#### **Connection Diagram**

#### Pin Assignments for DIP and SOIC



#### **Truth Table**

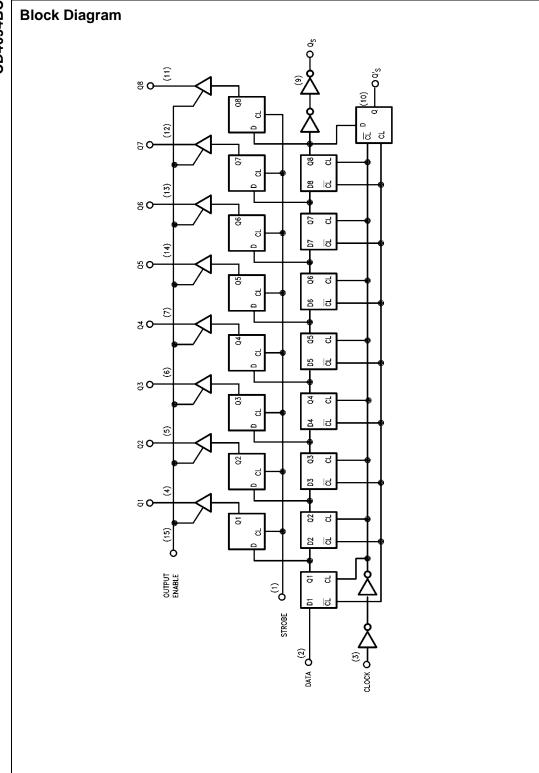
Clock	Output	Strobe	Data	Parallel Outputs		Serial (	Outputs	
	Enable			Q1	Q <sub>N</sub>	Q <sub>S</sub> (Note 1)	$\mathbf{Q'}_{\Sigma}$	
	0	Х	Х	Hi-Z	Hi-Z	Q7	No Change	
~	0	Х	Х	Hi-Z	Hi-Z	No Change	Q7	
	1	0	X	No Change	No Change	Q7	No Change	
	1	1	0	0	Q <sub>N</sub> -1	Q7	No Change	
	1	1	1	1	Q <sub>N</sub> -1	Q7	No Change	
~	1	1	1	No Change	No Change	No Change	Q7	

X = Don't Care

= HIGH-to-LOW

Note 1: At the positive clock edge, information in the 7th shift register stage is transferred to Q8 and Q<sub>S</sub>.

<sup>=</sup> HIGH-to-LOW



### Absolute Maximum Ratings(Note 2)

(Note 3)

Power Dissipation (P<sub>D</sub>)

Dual-In-Line 700 mW Small Outline 500 mW

Lead Temperature (T<sub>L</sub>)

(Soldering, 10 seconds) 260°C

## Recommended Operating Conditions (Note 3)

DC Supply Voltage ( $V_{DD}$ ) +3.0 to +15  $V_{DC}$ Input Voltage ( $V_{IN}$ ) 0 to  $V_{DD}$   $V_{DC}$ Operating Temperature Range ( $T_A$ ) -40°C to +85°C

Note 2: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed; they are not meant to imply that the devices should be operated at these limits. The tables of "Recommended Operating Conditions" and "Electrical Characteristics" provide conditions for actual device operation.

Note 3:  $V_{SS} = 0V$  unless otherwise specified.

### DC Electrical Characteristics (Note 3)

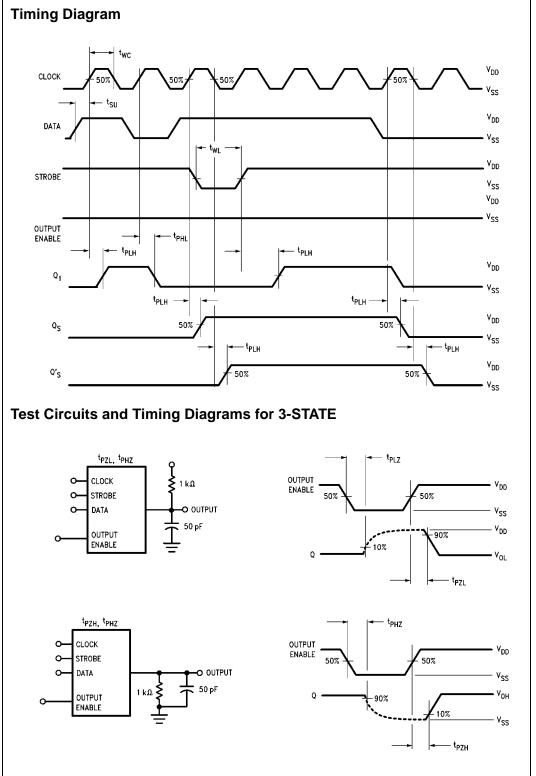
Symbol	Parameter	Conditions	–40°C		+25°C			+85°C		Units
Symbol		Conditions	Min	Max	Min	Тур	Max	Min	Max	Jillis
I <sub>DD</sub>	Quiescent	V <sub>DD</sub> = 5.0V		20			20		150	μА
	Device Current	$V_{DD} = 10V$		40			40		300	μΑ
		V <sub>DD</sub> = 15V		80			80		600	μΑ
V <sub>OL</sub>	LOW Level	V <sub>DD</sub> = 5.0V		0.05		0	0.05		0.05	V
	Output Voltage	$V_{DD} = 10V$ $ I_{O}  \le 1.0 \mu A$		0.05		0	0.05		0.05	V
		V <sub>DD</sub> = 15V		0.05		0	0.05		0.05	V
V <sub>OH</sub>	HIGH Level	V <sub>DD</sub> = 5.0V	4.95		4.95	5.0		4.95		V
	Output Voltage	$V_{DD} = 10V$ $ I_O  \le 1 \mu A$	9.95		9.95	10.0		9.95		V
		V <sub>DD</sub> = 15V	14.95		14.95	15.0		14.95		V
V <sub>IL</sub>	LOW Level	$V_{DD} = 5.0V, V_{O} = 0.5V \text{ or } 4.5V$		1.5			1.5		1.5	V
	Input Voltage	$V_{DD} = 10V, V_{O} = 1.0V \text{ or } 9.0V$		3.0			3.0		3.0	V
		$V_{DD} = 15V, V_{O} = 1.5V \text{ or } 13.5V$		4.0			4.0		4.0	V
V <sub>IH</sub>	HIGH Level	$V_{DD} = 5.0V, V_{O} = 0.5V \text{ or } 4.5V$	3.5		3.5			3.5		V
	Input Voltage	$V_{DD} = 10V, V_{O} = 1.0V \text{ or } 9.0V$	7.0		7.0			7.0		V
		$V_{DD} = 15V, V_{O} = 1.5V \text{ or } 13.5V$	11.0		11.0			11.0		V
I <sub>OL</sub>	LOW Level	$V_{DD} = 5.0V, V_{O} = 0.4V$	0.52		0.44	0.88		0.36		mA
	Output Current	$V_{DD} = 10V, V_{O} = 0.5V$	1.3		1.1	2.25		0.9		mA
	(Note 4)	$V_{DD} = 15V, V_{O} = 1.5V$	3.6		3.0	8.8		2.4		mA
I <sub>OH</sub>	HIGH Level	$V_{DD} = 5.0V, V_{O} = 4.6V$	-0.52		-0.44	0.88		-0.36		mA
	Output Current	$V_{DD} = 10V, V_{O} = 9.5V$	-1.3		-1.1	2.25		-0.9		mA
	(Note 4)	$V_{DD} = 15V, V_{O} = 13.5V$	-3.6		-3.0	8.8		-2.4		mA
I <sub>IN</sub>	Input Current	$V_{DD} = 15V, V_{IN} = 0V$		-0.3			-0.3		-1.0	μΑ
		$V_{DD} = 15V, V_{IN} = 15V$		0.3			0.3		1.0	μΑ
I <sub>OZ</sub>	3-STATE Output	$V_{DD} = 15V, V_{IN} = 0V \text{ or } 15V$		1			1		10	μΑ
	Leakage Current									

Note 4:  $I_{OH}$  and  $I_{OL}$  are tested one output at a time.

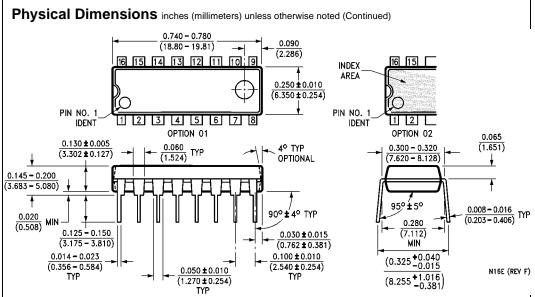
# AC Electrical Characteristics (Note 5) $T_A = 25$ °C, $C_L = 50$ pF

Symbol	Parameter	Conditions	Min	Тур	Max	Units
t <sub>PHL</sub> , t <sub>PLH</sub>	Propagation Delay	V <sub>DD</sub> = 5.0V		300	600	ns
	Clock to Q <sub>S</sub>	$V_{DD} = 10V$		125	250	ns
		$V_{DD} = 15V$		95	190	ns
t <sub>PHL</sub> , t <sub>PLH</sub>	Propagation Delay	V <sub>DD</sub> = 5.0V		230	460	ns
	Clock to $Q'_{\Sigma}$	$V_{DD} = 10V$		110	220	ns
		$V_{DD} = 15V$		75	150	ns
t <sub>PHL</sub> , t <sub>PLH</sub>	Propagation Delay Clock	V <sub>DD</sub> = 5.0V		420	840	ns
	to Parallel Out	$V_{DD} = 10V$		195	390	ns
		$V_{DD} = 15V$		135	270	ns
t <sub>PHL</sub> , t <sub>PLH</sub>	Propagation Delay Strobe	V <sub>DD</sub> = 5.0V		290	580	ns
	to Parallel Out	$V_{DD} = 10V$		145	290	ns
		$V_{DD} = 15V$		100	200	ns
t <sub>PHZ</sub>	Propagation Delay HIGH	V <sub>DD</sub> = 5.0V		140	280	ns
	Level to HIGH Impedance	$V_{DD} = 10V$		75	150	ns
		$V_{DD} = 15V$		55	110	ns
t <sub>PLZ</sub>	Propagation Delay LOW	$V_{DD} = 5.0V$		140	280	ns
	Level to HIGH Impedance	$V_{DD} = 10V$		75	150	ns
		$V_{DD} = 15V$		55	110	ns
t <sub>PZH</sub>	Propagation Delay HIGH	V <sub>DD</sub> = 5.0V		140	280	ns
	Impedance to HIGH Level	$V_{DD} = 10V$		75	150	ns
		$V_{DD} = 15V$		55	110	ns
t <sub>PZL</sub>	Propagation Delay HIGH	V <sub>DD</sub> = 5.0V		140	280	ns
	Impedance to LOW Level	$V_{DD} = 10V$		75	150	ns
		$V_{DD} = 15V$		55	110	ns
t <sub>THL</sub> , t <sub>TLH</sub>	Transition Time	V <sub>DD</sub> = 5.0V		100	200	ns
		$V_{DD} = 10V$		50	100	ns
		$V_{DD} = 15V$		40	80	ns
t <sub>SU</sub>	Set-Up Time	V <sub>DD</sub> = 5.0V	80	40		ns
	Data to Clock	$V_{DD} = 10V$	40	20		ns
		$V_{DD} = 15V$	20	10		ns
$t_r$ , $t_f$	Maximum Clock Rise	$V_{DD} = 5.0V$	1			ms
	and Fall Time	$V_{DD} = 10V$	1			ms
		$V_{DD} = 15V$	1			ms
t <sub>PC</sub>	Minimum Clock	V <sub>DD</sub> = 5.0V	200	100		ns
	Pulse Width	$V_{DD} = 10V$	100	50		ns
		$V_{DD} = 15V$	83	40		ns
t <sub>PS</sub>	Minimum Strobe	V <sub>DD</sub> = 5.0V	200	100		ns
	Pulse Width	$V_{DD} = 10V$	80	40		ns
		$V_{DD} = 15V$	70	35		ns
f <sub>max</sub>	Maximum Clock Frequency	V <sub>DD</sub> = 5.0V	1.5	3.0		MHz
		$V_{DD} = 10V$	3.0	6.0		MHz
		$V_{DD} = 15V$	4.0	8.0		MHz
C <sub>IN</sub>	Input Capacitance	Any Input		5.0	7.5	pF

Note 5: AC Parameters are guaranteed by DC correlated testing.



# Physical Dimensions inches (millimeters) unless otherwise noted 0.2914-0.2992 7.4-7.6 0.3940-0.4190 10.00-10.65 0.0138-0.0200 0.350-0.508 TYP 0.010 A C S B $\frac{0.0091 - 0.0125}{0.23 - 0.32} \ \text{TYP ALL LEADS}$ 45° X $\frac{0.010-0.029}{0.25-0.75}$ 0.0926-0.1043 2.35-2.65 0.0040-0.0118 SEATING PLANE $\triangle \frac{0.004}{0.1}$ ALL LEAD TIPS B MAX TYP ALL LEADS 0.0160-0.0500 0.40-1.27 TYP ALL LEADS 16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide M16B



16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N16E

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